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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

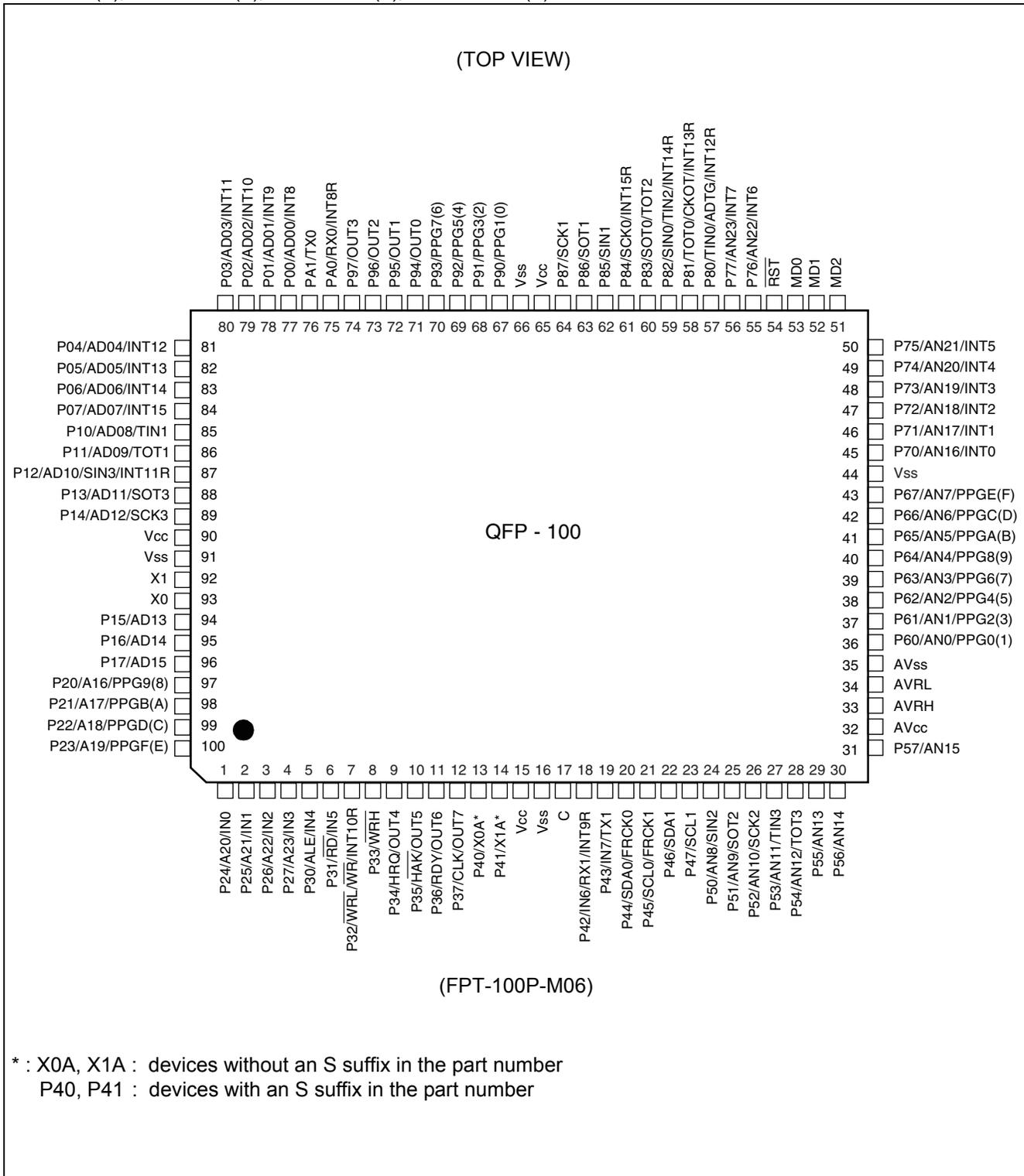
Product Status	Active
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	24MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, UART/USART
Peripherals	DMA, POR, WDT
Number of I/O	80
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 24x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f346cepf-ge1

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Part Number	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
External Interrupt (16 channels)	Can be used rising edge, falling edge, starting up by H/L level input, external interrupt, expanded intelligent I/O services (EI ² OS) and DMA		
D/A Converter	2 channels	—	
Sub clock (maximum 100 kHz)	Only for MB90V340E-102	Devices with sub clock : devices without an S suffix in the part number Devices without sub clock : devices with an S suffix in the part number	
I/O Ports	Virtually all external pins can be used as general purpose I/O port All ports are push-pull outputs Bit-wise settable as input/output or peripheral signal Can be configured 8 as CMOS schmitt trigger/ automotive inputs (in blocks of 8 pins) TTL input level settable for external bus (32-pin only for external bus)		
Flash Memory	—	Supports automatic programming, Embedded Algorithm Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Number of erase cycles : 10000 cycles Data retention time : 20 years Boot block configuration Erase can be performed on each block Block protection with external programming voltage Flash Security Feature for protecting the content of the Flash (except for MB90F346E(S) and MB90F346CE (S))	

* : It is setting of Jumper switch (TOOL VCC) when Emulator (MB2147-01-E) is used.
Please refer to the Emulator operation manual for details.

■ MB90341CE(S), MB90342CE(S), MB90F342CE(S), MB90F345CE(S), MB90346CE(S), MB90F346CE(S), MB90347CE(S), MB90F347CE(S), MB90348CE(S), MB90349CE(S), MB90F349CE(S)



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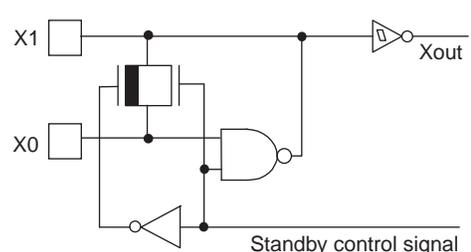
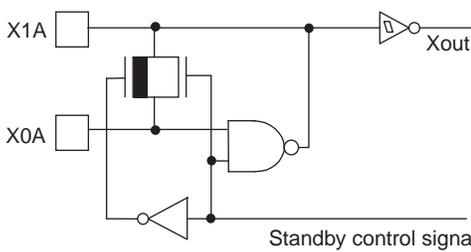
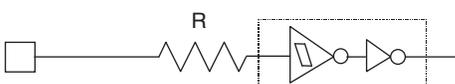
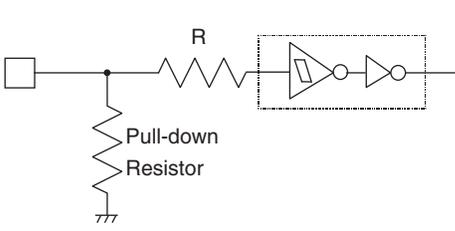
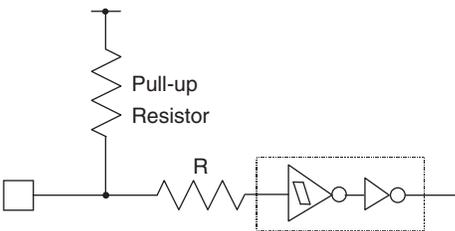
Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
61	59	P84	F	General purpose I/O pin.
		SCK0		Clock I/O pin for UART0
		INT15R		External interrupt request input pin
62	60	P85	M	General purpose I/O pin.
		SIN1		Serial data input pin for UART1
63	61	P86	F	General purpose I/O pin.
		SOT1		Serial data output pin for UART1
64	62	P87	F	General purpose I/O pin.
		SCK1		Clock I/O pin for UART1
65	63	V _{CC}	—	Power (3.5 V to 5.5 V) input pin
66	64	V _{SS}	—	GND pin
67 to 70	65 to 68	P90 to P93	F	General purpose I/O pins
		PPG1, 3, 5, 7		Output pins for PPGs
71 to 74	69 to 72	P94 to P97	F	General purpose I/O pins
		OUT0 to OUT3		Waveform output pins for output compares. This function is enabled when the OCU enables waveform output.
75	73	PA0	F	General purpose I/O pin.
		RX0		RX input pin for CAN0 Interface
		INT8R		External interrupt request input pin
76	74	PA1	F	General purpose I/O pin.
		TX0		TX Output pin for CAN0
77 to 84	75 to 82	P00 to P07	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
		INT8 to INT15		External interrupt request input pins.
85	83	P10	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD08		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		TIN1		Event input pin for the reload timer

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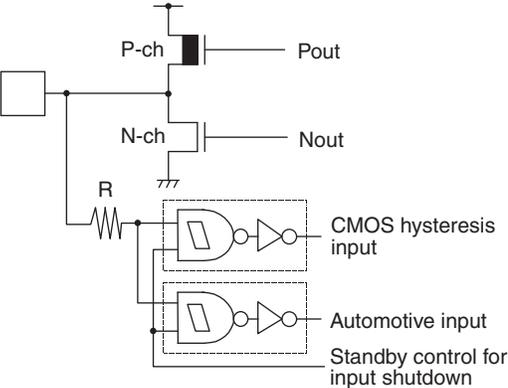
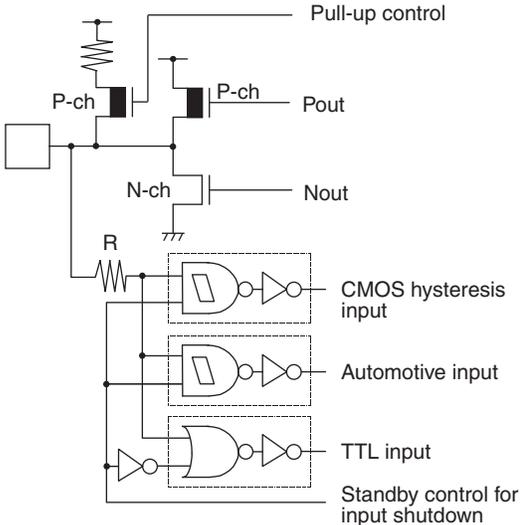
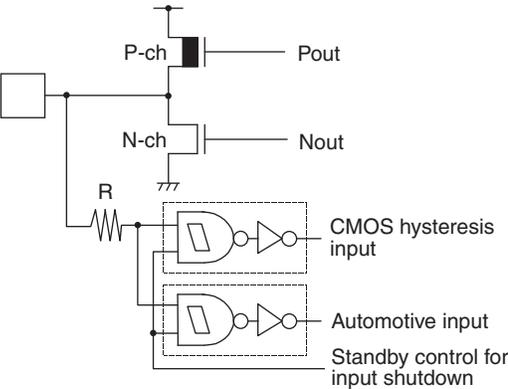
Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
86	84	P11	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD09		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		TOT1		Output pin for the reload timer
87	85	P12	N	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD10		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		SIN3		Serial data input pin for UART3
		INT11R		External interrupt request input pin
88	86	P13	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD11		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		SOT3		Serial data output pin for UART3
89	87	P14	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD12		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		SCK3		Clock I/O pin for UART3
90	88	V _{CC}	—	Power (3.5 V to 5.5 V) input pin
91	89	V _{SS}	—	GND pin
92	90	X1	A	Main clock output pin
93	91	X0		Main clock input pin
94	92	P15	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD13		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
95	93	P16	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD14		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.

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4. I/O Circuit Type

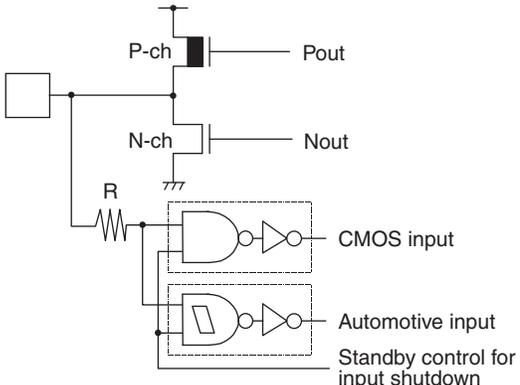
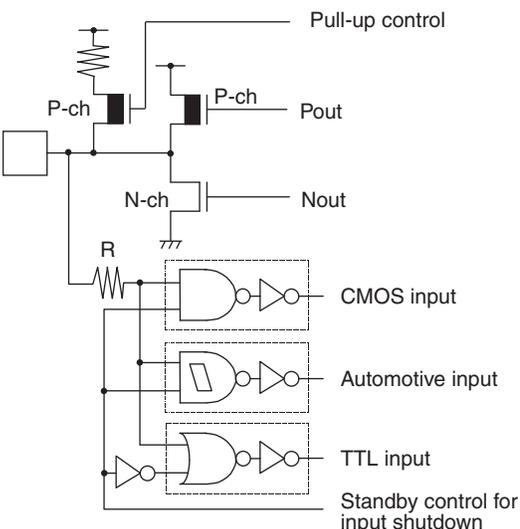
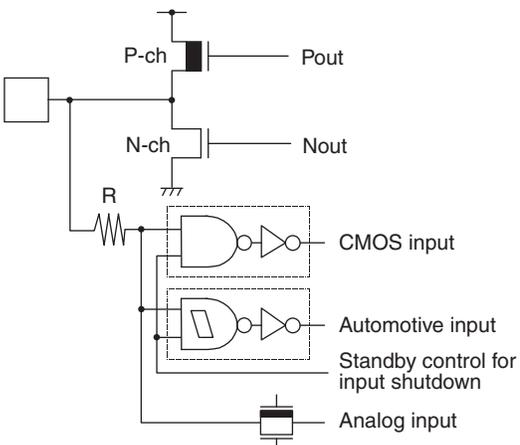
Type	Circuit	Remarks
A		<p>Oscillation circuit High-speed oscillation feedback resistor = approx. 1 MΩ</p>
B		<p>Oscillation circuit Low-speed oscillation feedback resistor = approx. 10 MΩ</p>
C		<ul style="list-style-type: none"> ■ MASK ROM and evaluation products: CMOS hysteresis input pin ■ Flash memory products: CMOS input pin
D		<p>MASK ROM and evaluation products:</p> <ul style="list-style-type: none"> ■ CMOS hysteresis input pin ■ Pull-down resistor value: approx. 50 kΩ <p>Flash memory products:</p> <ul style="list-style-type: none"> ■ CMOS input pin ■ No pull-down
E		<p>CMOS hysteresis input pin Pull-up resistor value: approx. 50 kΩ</p>

(Continued)

Type	Circuit	Remarks
F		<ul style="list-style-type: none"> ■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby)
G		<ul style="list-style-type: none"> ■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ TTL input (with function to disconnect input during standby) ■ Programmable pull-up resistor: 50 kΩ approx.
H		<ul style="list-style-type: none"> ■ CMOS level output ($I_{OL} = 3 \text{ mA}$, $I_{OH} = -3 \text{ mA}$) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby)

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Type	Circuit	Remarks
M		<ul style="list-style-type: none"> ■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby)
N		<ul style="list-style-type: none"> ■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ TTL input (with function to disconnect input during standby) Programmable pull-up resistor: 50 kΩ approx
O		<ul style="list-style-type: none"> ■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input

Address	Register	Abbreviation	Access	Resource name	Initial value
0000C4 _H , 0000C5 _H	Reserved				
0000C6 _H	External Interrupt Enable 0	ENIR0	R/W	External Interrupt 0	00000000 _B
0000C7 _H	External Interrupt Source 0	EIRR0	R/W		XXXXXXXX _B
0000C8 _H	External Interrupt Level Setting 0	ELVR0	R/W		00000000 _B
0000C9 _H	External Interrupt Level Setting 0	ELVR0	R/W		00000000 _B
0000CA _H	External Interrupt Enable 1	ENIR1	R/W	External Interrupt 1	00000000 _B
0000CB _H	External Interrupt Source 1	EIRR1	R/W		XXXXXXXX _B
0000CC _H	External Interrupt Level Setting 1	ELVR1	R/W		00000000 _B
0000CD _H	External Interrupt Level Setting 1	ELVR1	R/W		00000000 _B
0000CE _H	External Interrupt Source Select	EISSR	R/W		00000000 _B
0000CF _H	PLL/Sub clock Control Register	PSCCR	W	PLL	XXXX0000 _B
0000D0 _H	DMA Buffer Address Pointer L Register	BAPL	R/W	DMA	XXXXXXXX _B
0000D1 _H	DMA Buffer Address Pointer M Register	BAPM	R/W		XXXXXXXX _B
0000D2 _H	DMA Buffer Address Pointer H Register	BAPH	R/W		XXXXXXXX _B
0000D3 _H	DMA Control Register	DMACS	R/W		XXXXXXXX _B
0000D4 _H	I/O Register Address Pointer L Register	IOAL	R/W		XXXXXXXX _B
0000D5 _H	I/O Register Address Pointer H Register	IOAH	R/W		XXXXXXXX _B
0000D6 _H	Data Counter L Register	DCTL	R/W		XXXXXXXX _B
0000D7 _H	Data Counter H Register	DCTH	R/W	XXXXXXXX _B	
0000D8 _H	Serial Mode Register 2	SMR2	W,R/W	UART2	00000000 _B
0000D9 _H	Serial Control Register 2	SCR2	W,R/W		00000000 _B
0000DA _H	Reception/Transmission Data Register 2	RDR2/TDR2	R/W		00000000 _B
0000DB _H	Serial Status Register 2	SSR2	R,R/W		00001000 _B
0000DC _H	Extended Communication Control Register 2	ECCR2	R,W, R/W		000000XX _B
0000DD _H	Extended Status Control Register 2	ESCR2	R/W		00000100 _B
0000DE _H	Baud Rate Generator Register 20	BGR20	R/W		00000000 _B
0000DF _H	Baud Rate Generator Register 21	BGR21	R/W	00000000 _B	
0000E0 _H to 0000EF _H	Reserved for CAN Controller 2. Refer to "CAN Controllers"				
0000F0 _H to 0000FF _H	External				

(Continued)

List of Control Registers (2)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
007B00 _H	007D00 _H	Control Status Register	CSR	R/W, W R/W, R	0XXXX0X1 _B 00XXX000 _B
007B01 _H	007D01 _H				
007B02 _H	007D02 _H	Last Event Indicator Register	LEIR	R/W	000X0000 _B XXXXXXXX _B
007B03 _H	007D03 _H				
007B04 _H	007D04 _H	Receive And Transmit Error Counter	RTEC	R	00000000 _B 00000000 _B
007B05 _H	007D05 _H				
007B06 _H	007D06 _H	Bit Timing Register	BTR	R/W	11111111 _B X1111111 _B
007B07 _H	007D07 _H				
007B08 _H	007D08 _H	IDE Register	IDER	R/W	XXXXXXXX _B XXXXXXXX _B
007B09 _H	007D09 _H				
007B0A _H	007D0A _H	Transmit RTR Register	TRTRR	R/W	00000000 _B 00000000 _B
007B0B _H	007D0B _H				
007B0C _H	007D0C _H	Remote Frame Receive Waiting Register	RFWTR	R/W	XXXXXXXX _B XXXXXXXX _B
007B0D _H	007D0D _H				
007B0E _H	007D0E _H	Transmit Interrupt Enable Register	TIER	R/W	00000000 _B 00000000 _B
007B0F _H	007D0F _H				
007B10 _H	007D10 _H	Acceptance Mask Select Register	AMSR	R/W	XXXXXXXX _B XXXXXXXX _B
007B11 _H	007D11 _H				
007B12 _H	007D12 _H				XXXXXXXX _B XXXXXXXX _B
007B13 _H	007D13 _H				
007B14 _H	007D14 _H	Acceptance Mask Register 0	AMR0	R/W	XXXXXXXX _B XXXXXXXX _B
007B15 _H	007D15 _H				
007B16 _H	007D16 _H				XXXXXXXX _B XXXXXXXX _B
007B17 _H	007D17 _H				
007B18 _H	007D18 _H	Acceptance Mask Register 1	AMR1	R/W	XXXXXXXX _B XXXXXXXX _B
007B19 _H	007D19 _H				
007B1A _H	007D1A _H				XXXXXXXX _B XXXXXXXX _B
007B1B _H	007D1B _H				

List of Message Buffers (DLC Registers and Data Registers) (2)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
007A80 _H to 007A87 _H	007C80 _H to 007C87 _H	Data Register 0 (8 bytes)	DTR0	R/W	XXXXXXXX _B to XXXXXXXX _B
007A88 _H to 007A8F _H	007C88 _H to 007C8F _H	Data Register 1 (8 bytes)	DTR1	R/W	XXXXXXXX _B to XXXXXXXX _B
007A90 _H to 007A97 _H	007C90 _H to 007C97 _H	Data Register 2 (8 bytes)	DTR2	R/W	XXXXXXXX _B to XXXXXXXX _B
007A98 _H to 007A9F _H	007C98 _H to 007C9F _H	Data Register 3 (8 bytes)	DTR3	R/W	XXXXXXXX _B to XXXXXXXX _B
007AA0 _H to 007AA7 _H	007CA0 _H to 007CA7 _H	Data Register 4 (8 bytes)	DTR4	R/W	XXXXXXXX _B to XXXXXXXX _B
007AA8 _H to 007AAF _H	007CA8 _H to 007CAF _H	Data Register 5 (8 bytes)	DTR5	R/W	XXXXXXXX _B to XXXXXXXX _B
007AB0 _H to 007AB7 _H	007CB0 _H to 007CB7 _H	Data Register 6 (8 bytes)	DTR6	R/W	XXXXXXXX _B to XXXXXXXX _B
007AB8 _H to 007ABF _H	007CB8 _H to 007CBF _H	Data Register 7 (8 bytes)	DTR7	R/W	XXXXXXXX _B to XXXXXXXX _B
007AC0 _H to 007AC7 _H	007CC0 _H to 007CC7 _H	Data Register 8 (8 bytes)	DTR8	R/W	XXXXXXXX _B to XXXXXXXX _B
007AC8 _H to 007ACF _H	007CC8 _H to 007CCF _H	Data Register 9 (8 bytes)	DTR9	R/W	XXXXXXXX _B to XXXXXXXX _B
007AD0 _H to 007AD7 _H	007CD0 _H to 007CD7 _H	Data Register 10 (8 bytes)	DTR10	R/W	XXXXXXXX _B to XXXXXXXX _B
007AD8 _H to 007ADF _H	007CD8 _H to 007CDF _H	Data Register 11 (8 bytes)	DTR11	R/W	XXXXXXXX _B to XXXXXXXX _B
007AE0 _H to 007AE7 _H	007CE0 _H to 007CE7 _H	Data Register 12 (8 bytes)	DTR12	R/W	XXXXXXXX _B to XXXXXXXX _B
007AE8 _H to 007AEF _H	007CE8 _H to 007CEF _H	Data Register 13 (8 bytes)	DTR13	R/W	XXXXXXXX _B to XXXXXXXX _B

List of Message Buffers (DLC Registers and Data Registers) (3)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
007AF0 _H to 007AF7 _H	007CF0 _H to 007CF7 _H	Data Register 14 (8 bytes)	DTR14	R/W	XXXXXXXX _B to XXXXXXXX _B
007AF8 _H to 007AFF _H	007CF8 _H to 007CFF _H	Data Register 15 (8 bytes)	DTR15	R/W	XXXXXXXX _B to XXXXXXXX _B

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Interrupt cause	EI ² OS Support	DMA channel number	Interrupt vector		Interrupt control register	
			Number	Address	Number	Address
UART 2 RX / UART 4 RX	Y2	14	#39	FFFF60 _H	ICR14	0000BE _H
UART 2 TX / UART 4 TX	Y1	15	#40	FFFF5C _H		
Flash Memory	N	—	#41	FFFF58 _H	ICR15	0000BF _H
Delayed Interrupt	N	—	#42	FFFF54 _H		

Y1 : Usable

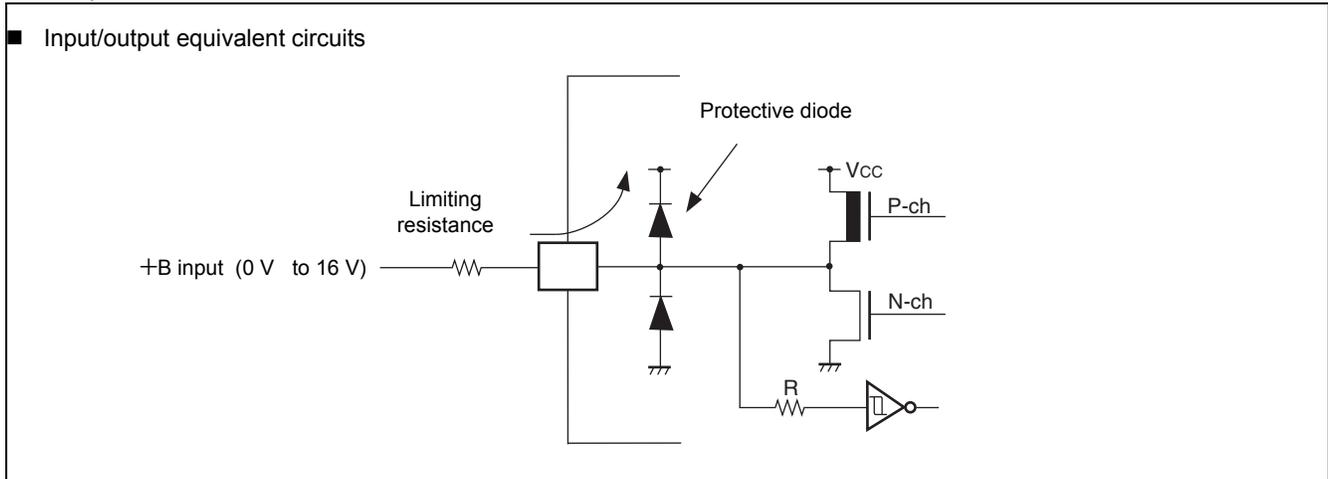
Y2 : Usable, with EI²OS stop function

N : Unusable

- Note:**
- The peripheral resources sharing the ICR register have the same interrupt level.
 - When two peripheral resources share the ICR register, only one can use Extended Intelligent I/O Service at a time.
 - When either of the two peripheral resources sharing the ICR register specifies Extended Intelligent I/O Service, the other one cannot use interrupts.

(Continued)

- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the +B input pin open.
- Sample recommended circuits:



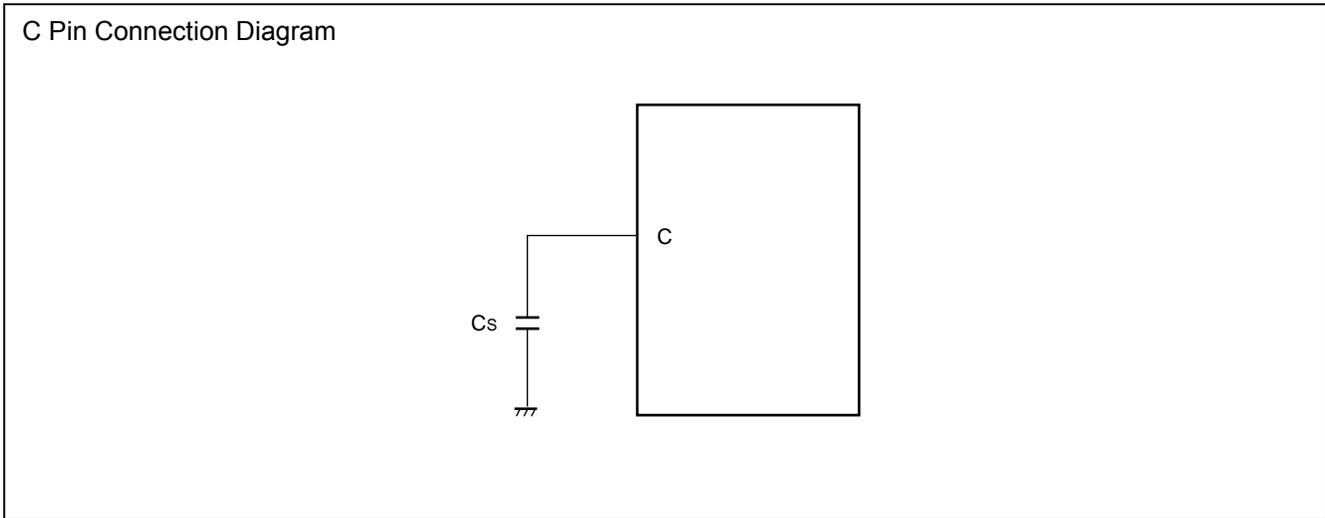
- *6: The maximum output current is defined as the peak value of the current of any one of the corresponding pins.
- *7: The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.
- *8: The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.2 Recommended Operating Conditions

($V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.0	5.0	5.5	V	Under normal operation
		3.5	5.0	5.5	V	Under normal operation, when not using the A/D converter and not Flash programming.
		4.5	5.0	5.5	V	When External bus is used.
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smoothing capacitor	C_S	0.1	—	1.0	μF	Use a ceramic capacitor or capacitor of better AC characteristics. Capacitor at the V_{CC} should be greater than this capacitor.
Operating temperature	T_A	-40	—	+105	$^{\circ}\text{C}$	

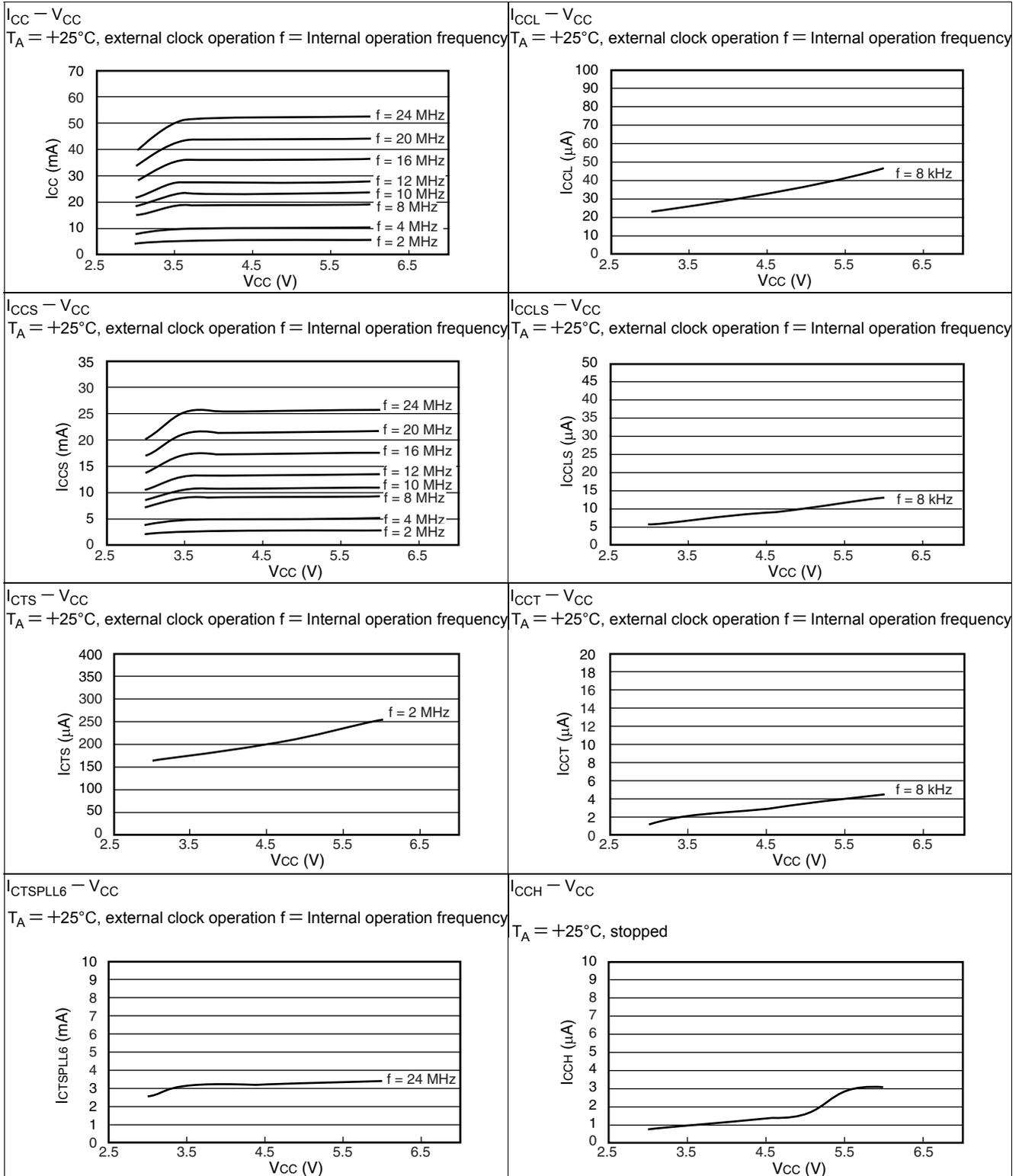


WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

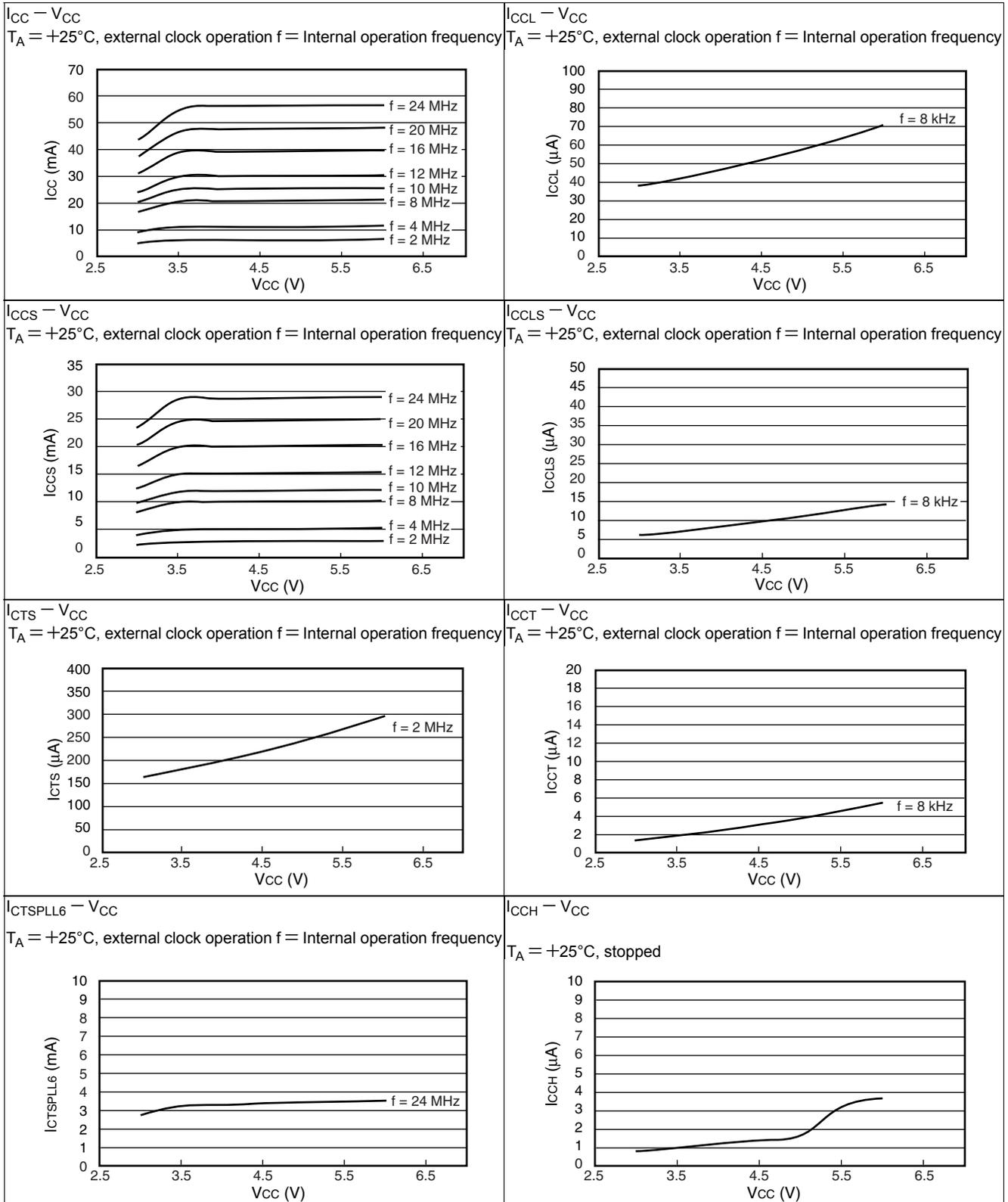
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

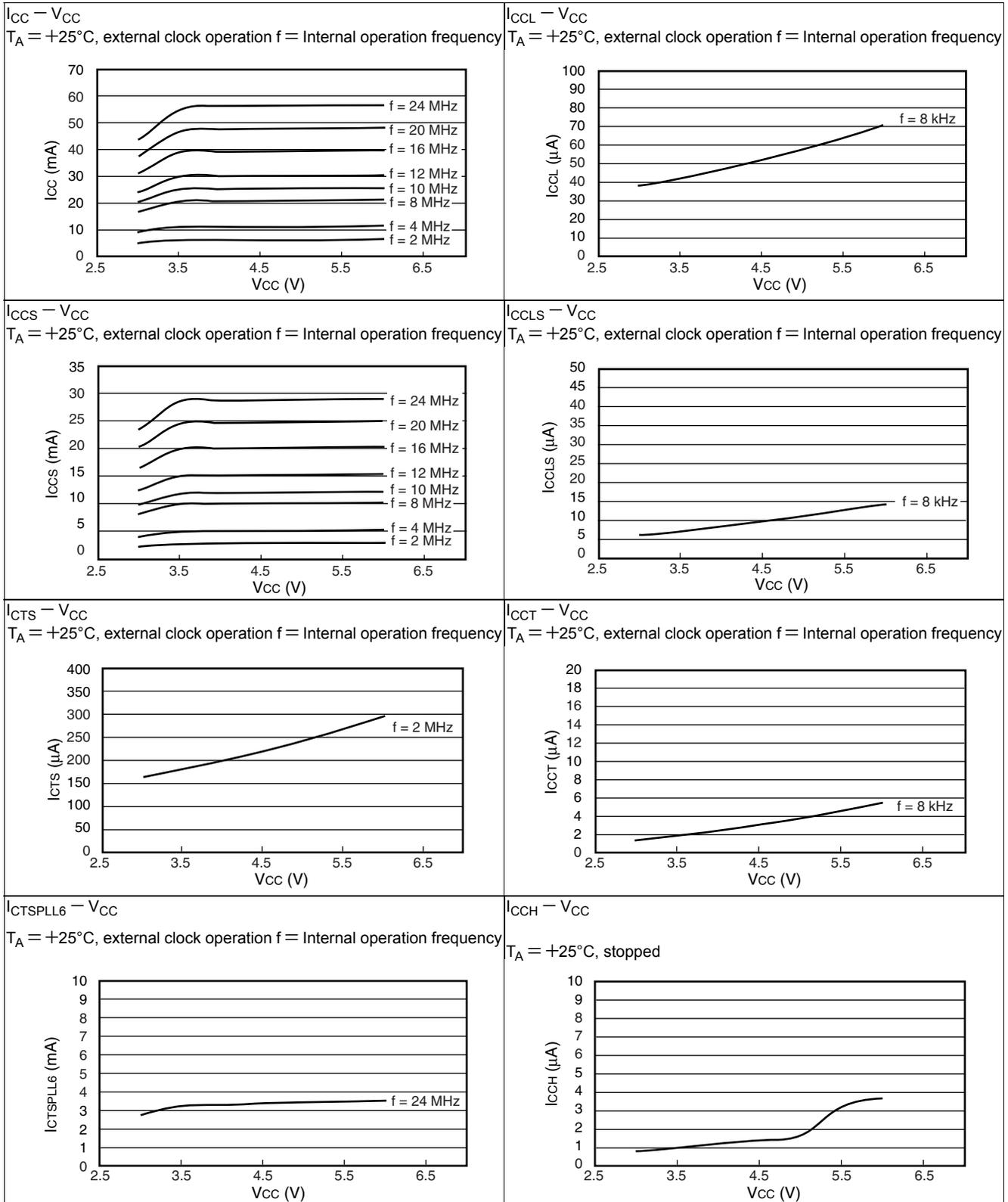
■ MB90F347E, MB90F347ES, MB90F347CE, MB90F347CES



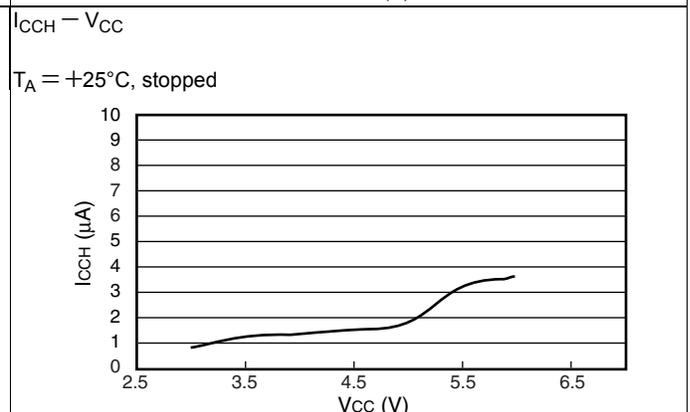
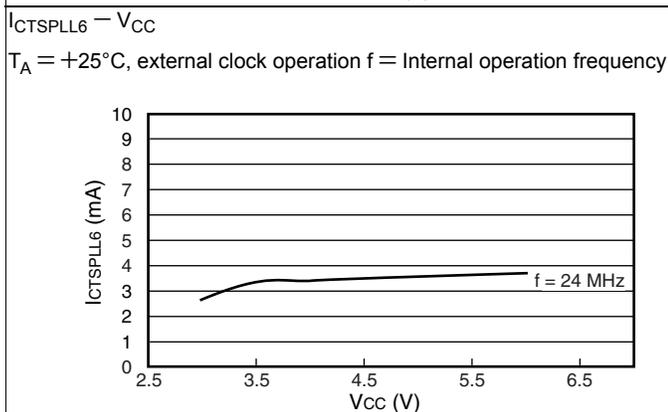
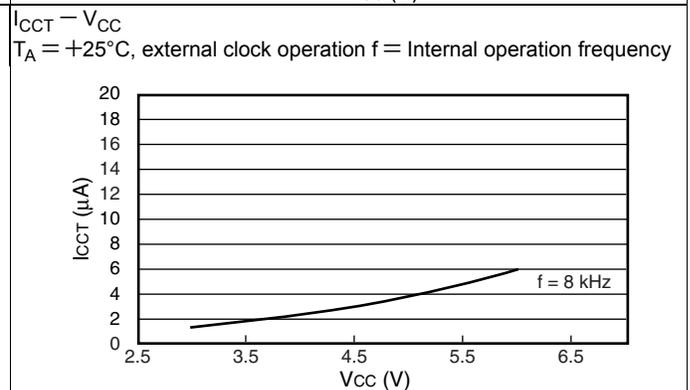
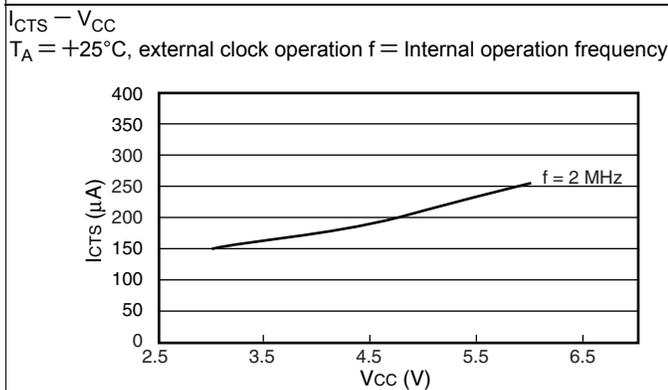
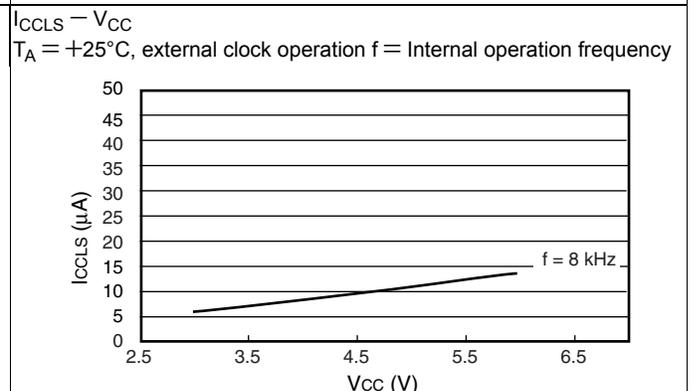
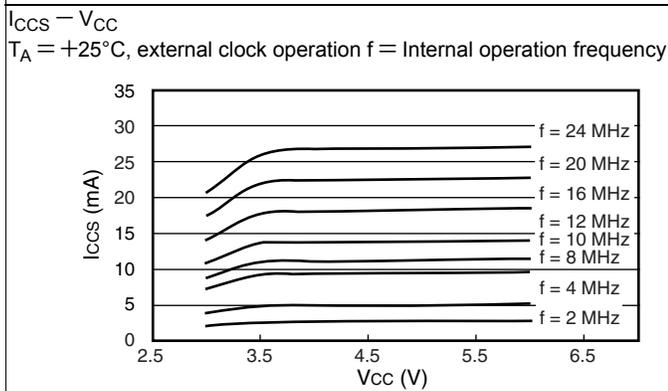
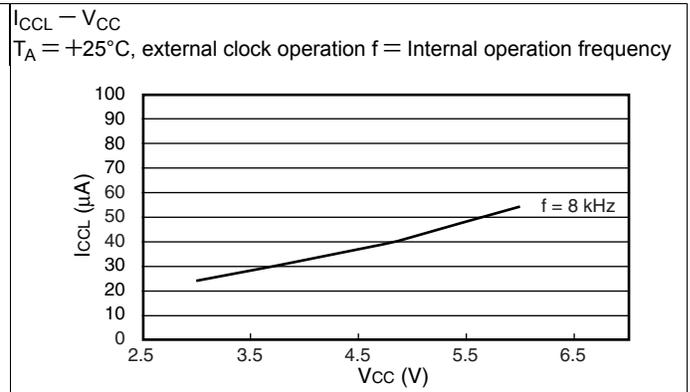
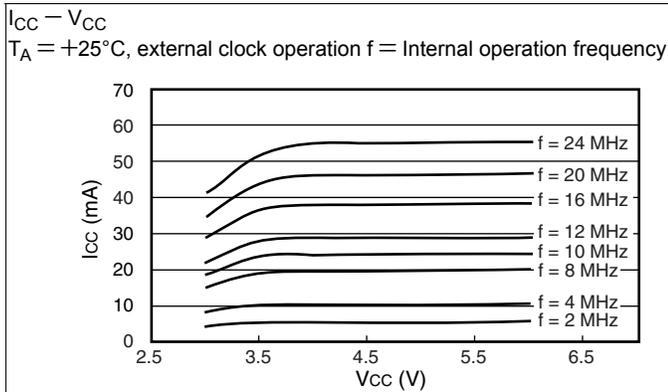
■ MB90F349E, MB90F349ES, MB90F349CE, MB90F349CES



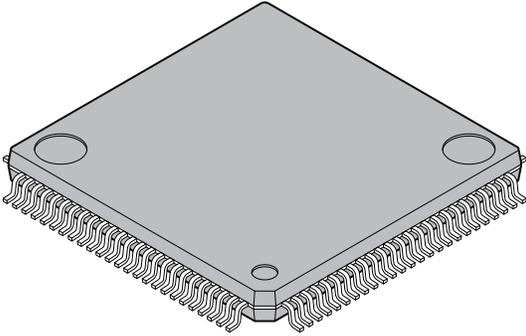
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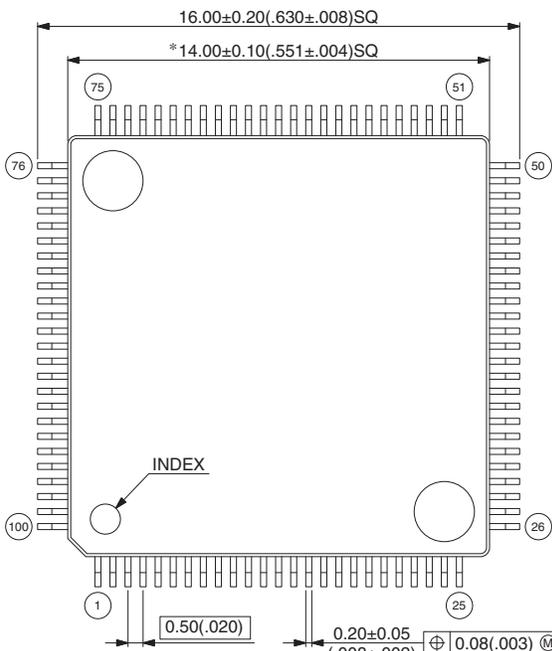
■ MB90346E, MB90346ES, MB90346CE, MB90346CES



14. Package Dimensions

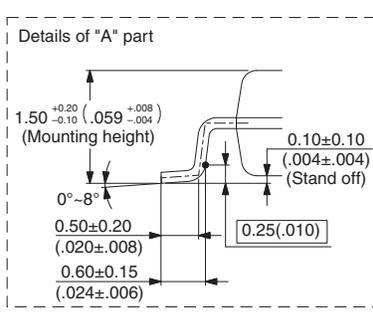
<p style="text-align: center;">100-pin plastic LQFP</p>  <p style="text-align: center;">(FPT-100P-M20)</p>	Lead pitch	0.50 mm
	Package width × package length	14.0 mm × 14.0 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.70 mm Max
	Weight	0.65 g
	Code (Reference)	P-LFQFP100-14×14-0.50

**100-pin plastic LQFP
(FPT-100P-M20)**



Note 1) * : These dimensions do not include resin protrusion.
 Note 2) Pins width and pins thickness include plating thickness.
 Note 3) Pins width do not include tie bar cutting remainder.

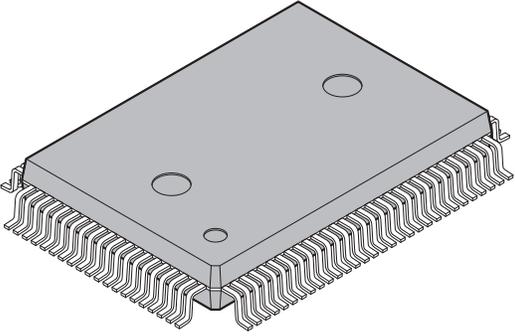
Details of "A" part



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Dimensions in mm (inches).
Note: The values in parentheses are reference values

(Continued)

<p style="text-align: center;">100-pin plastic QFP</p>  <p style="text-align: center;">(FPT-100P-M06)</p>	Lead pitch	0.65 mm
	Package width × package length	14.00 × 20.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	3.35 mm MAX
	Code (Reference)	P-QFP100-14×20-0.65

